



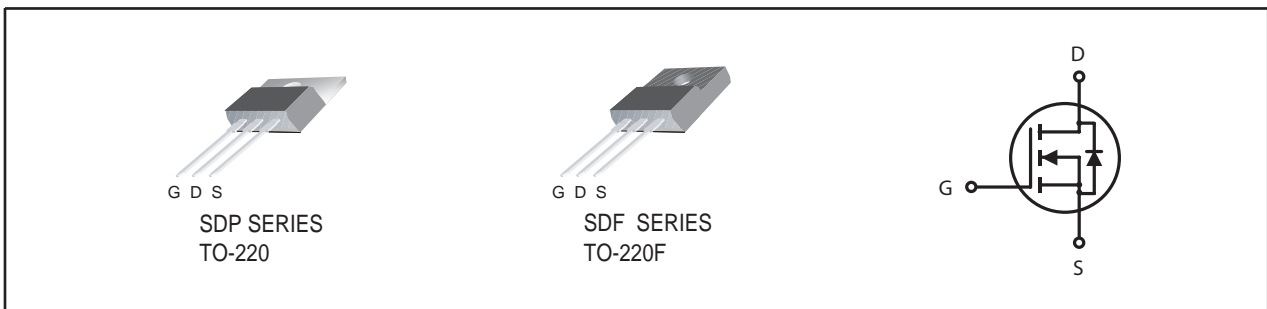
N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY

V _{DSS}	I _D	R _{DS(ON)} (Ω) Typ
800V	3.0A	3.3 @ V _{GS} =10V

FEATURES

- Super high dense cell design for low R_{DS(ON)}.
- Rugged and reliable.
- TO-220 and TO-220F Package.



ORDERING INFORMATION

Ordering Code	Package	Marking Code	Delivery Mode	RoHS Status
SDP03N80HZ	TO-220	SDP03N80	Tube	Halogen Free
SDP03N80PZ	TO-220	03N80	Tube	Pb Free
SDF03N80HZ	TO-220F	SDF03N80	Tube	Halogen Free
SDF03N80PZ	TO-220F	03N80	Tube	Pb Free

ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise noted)

Symbol	Parameter	SDP03N80	SDF03N80	Units	
V _{DS}	Drain-Source Voltage	800		V	
V _{GS}	Gate-Source Voltage	±30	±30	V	
I _D	Drain Current-Continuous ^a	T _C =25°C	3	3 ^e	A
		T _C =70°C	2.5	2.5 ^e	A
I _{DM}	-Pulsed ^b	8.9	8.9 ^e	A	
E _{AS}	Single Pulse Avalanche Energy ^d	100		mJ	
P _D	Maximum Power Dissipation ^a	T _C =25°C	84	42	W
		T _C =70°C	58	29	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 175		°C	

THERMAL CHARACTERISTICS

R _{θJC}	Thermal Resistance, Junction-to-Case ^a	1.8	3.6	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient ^a	62.5	62.5	°C/W

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ELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	800			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =640V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±30V , V _{DS} =0V			±100	nA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	3	4	5	V
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V , I _D =1.5A		3.3	4.2	ohm
g _{FS}	Forward Transconductance	V _{DS} =20V , I _D =1.5A		2.2		S
DYNAMIC CHARACTERISTICS ^c						
C _{ISS}	Input Capacitance	V _{DS} =25V, V _{GS} =0V f=1.0MHz		607		pF
C _{OSS}	Output Capacitance			60		pF
C _{RSS}	Reverse Transfer Capacitance			12		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =400V I _D =1A V _{GS} =10V R _{GEN} = 6 ohm		27		ns
t _r	Rise Time			21		ns
t _{D(OFF)}	Turn-Off Delay Time			30.5		ns
t _f	Fall Time			14.7		ns
Q _g	Total Gate Charge		V _{DS} =400V, I _D =1A, V _{GS} =10V		12.5	
Q _{gs}	Gate-Source Charge	V _{DS} =400V, I _D =1A, V _{GS} =10V		2.5		nC
Q _{gd}	Gate-Drain Charge			6		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =2A		0.81	1.4	V
Notes						
<p>a.Surface Mounted on FR4 Board, t ≤ 10sec.</p> <p>b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.</p> <p>c.Guaranteed by design, not subject to production testing.</p> <p>d.Starting T_J=25°C, L=50mH, V_{DD} = 50V.(See Figure12)</p> <p>e.Drain current limited by maximum junction temperatruue.</p>						

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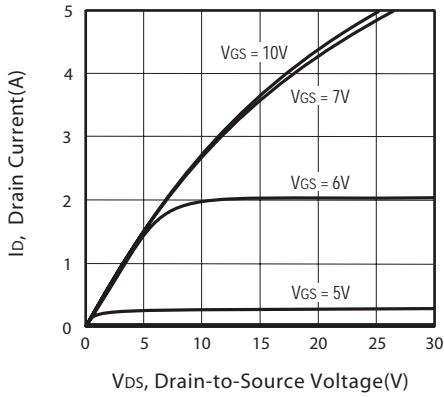


Figure 1. Output Characteristics

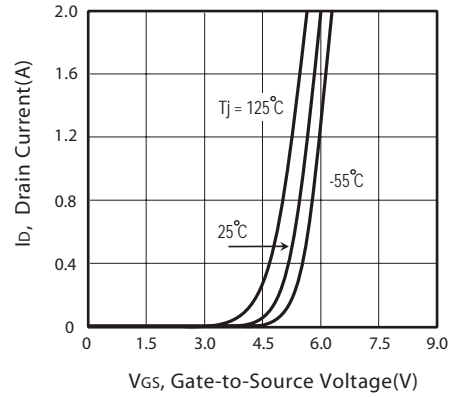


Figure 2. Transfer Characteristics

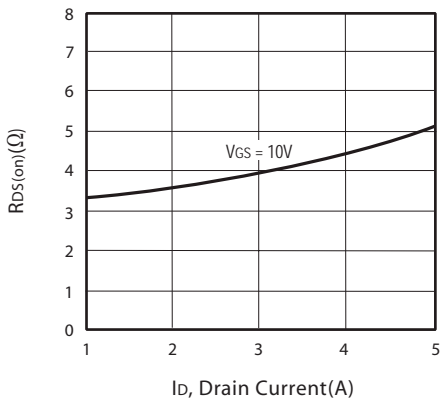


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

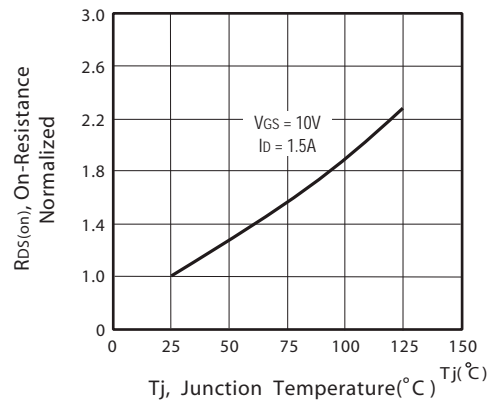


Figure 4. On-Resistance Variation with Drain Current and Temperature

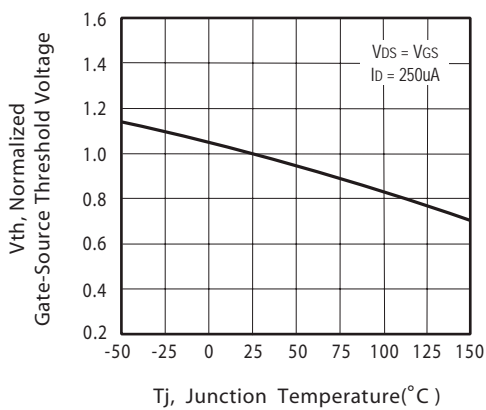


Figure 5. Gate Threshold Variation with Temperature

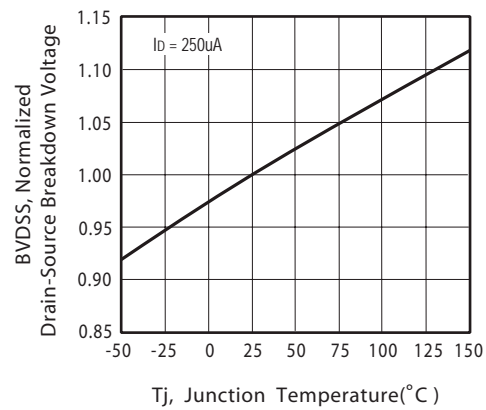


Figure 6. Breakdown Voltage Variation with Temperature

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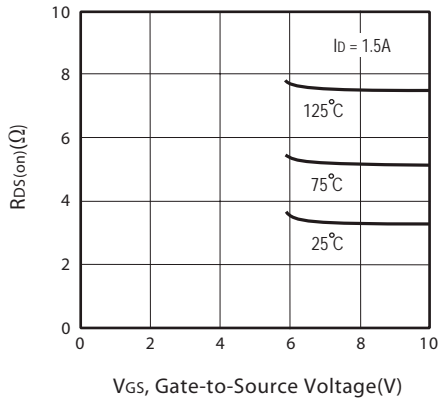


Figure 7. On-Resistance vs. Gate-Source Voltage

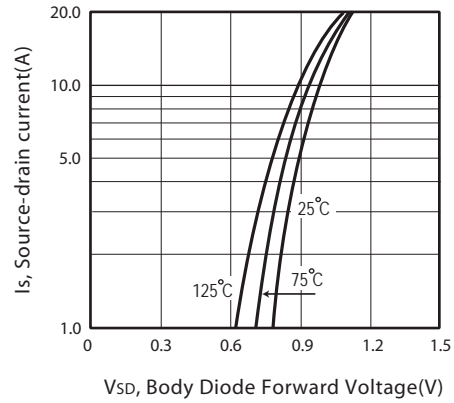


Figure 8. Body Diode Forward Voltage Variation with Source Current

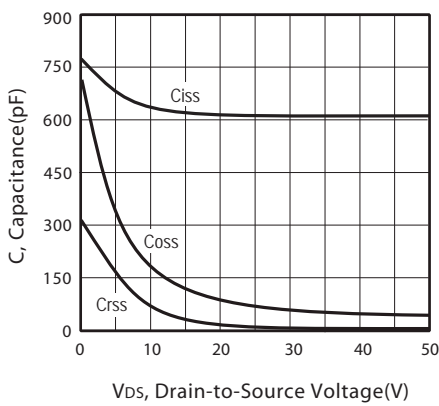


Figure 9. Capacitance

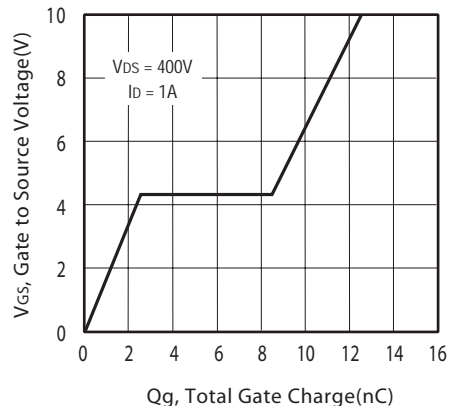


Figure 10. Gate Charge

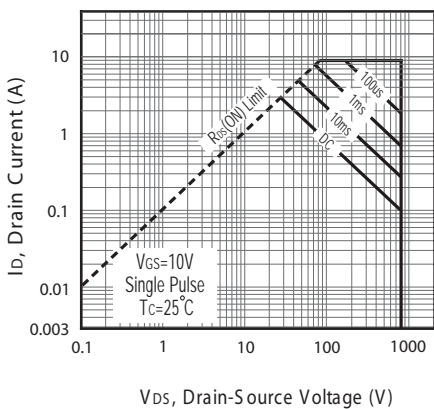


Figure 11a. Maximum Safe Operating Area for SDP03N80

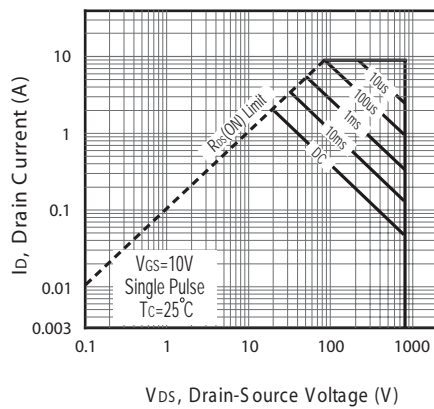


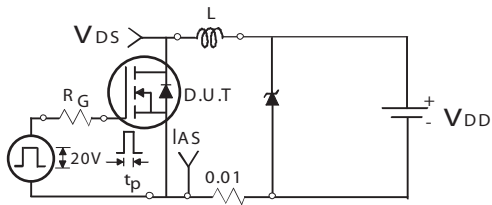
Figure 11b. Maximum Safe Operating Area for SDF03N80

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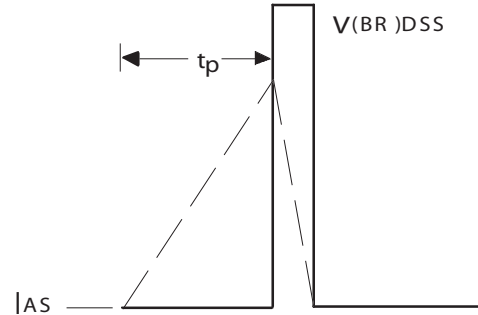
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Unclamped Inductive Test Circuit

Figure 12a.



Unclamped Inductive Waveforms

Figure 12b.

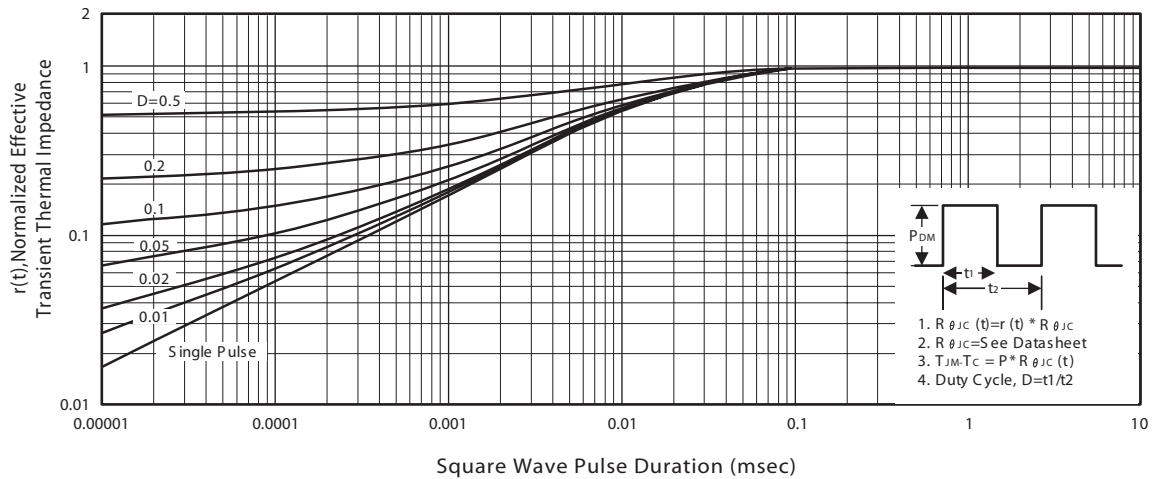


Figure 13a. Normalized Thermal Transient Impedance Curve for SDP03N80

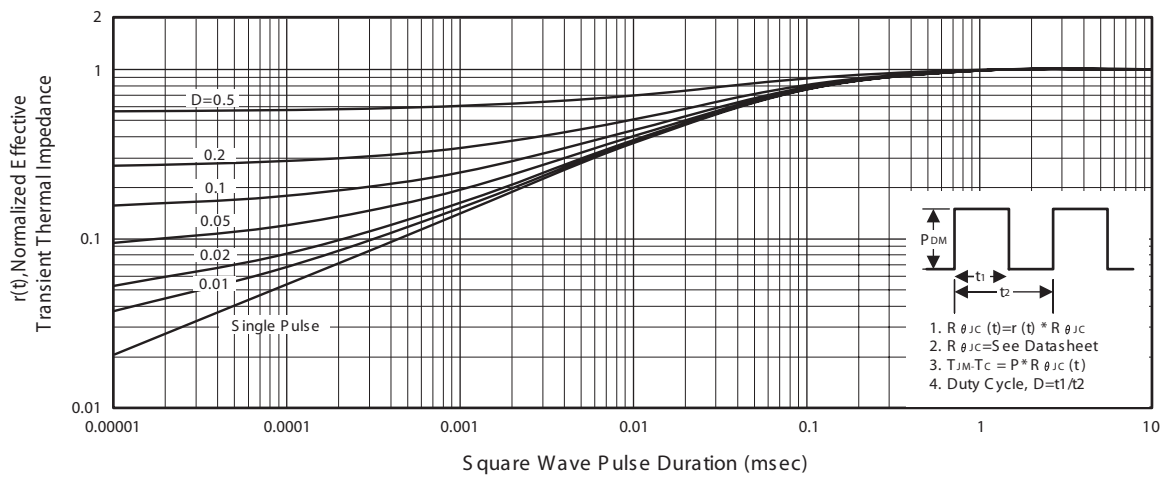


Figure 13b. Normalized Thermal Transient Impedance Curve for SDF03N80

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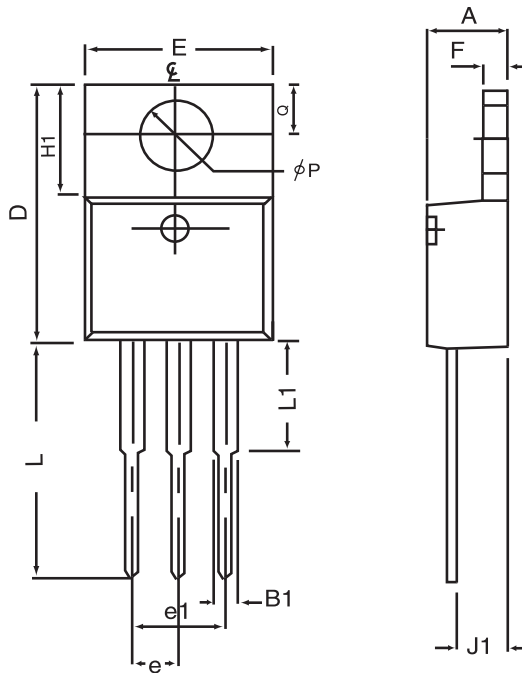
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PACKAGE OUTLINE DIMENSIONS

TO-220



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.32	4.80	0.170	0.189
B1	1.27	1.65	0.050	0.630
D	14.6	16.00	0.575	0.610
E	9.70	10.41	0.382	0.410
e	2.34	2.74	0.092	0.108
e1	4.68	5.48	0.184	0.216
F	1.14	1.40	0.045	0.055
H1	5.97	6.73	0.235	0.265
J1	2.20	2.79	0.087	0.110
L	12.88	14.22	0.507	0.560
L1	3.00	6.35	0.120	0.250
phi P	3.50	3.94	0.138	0.155
Q	2.54	3.05	0.100	0.120

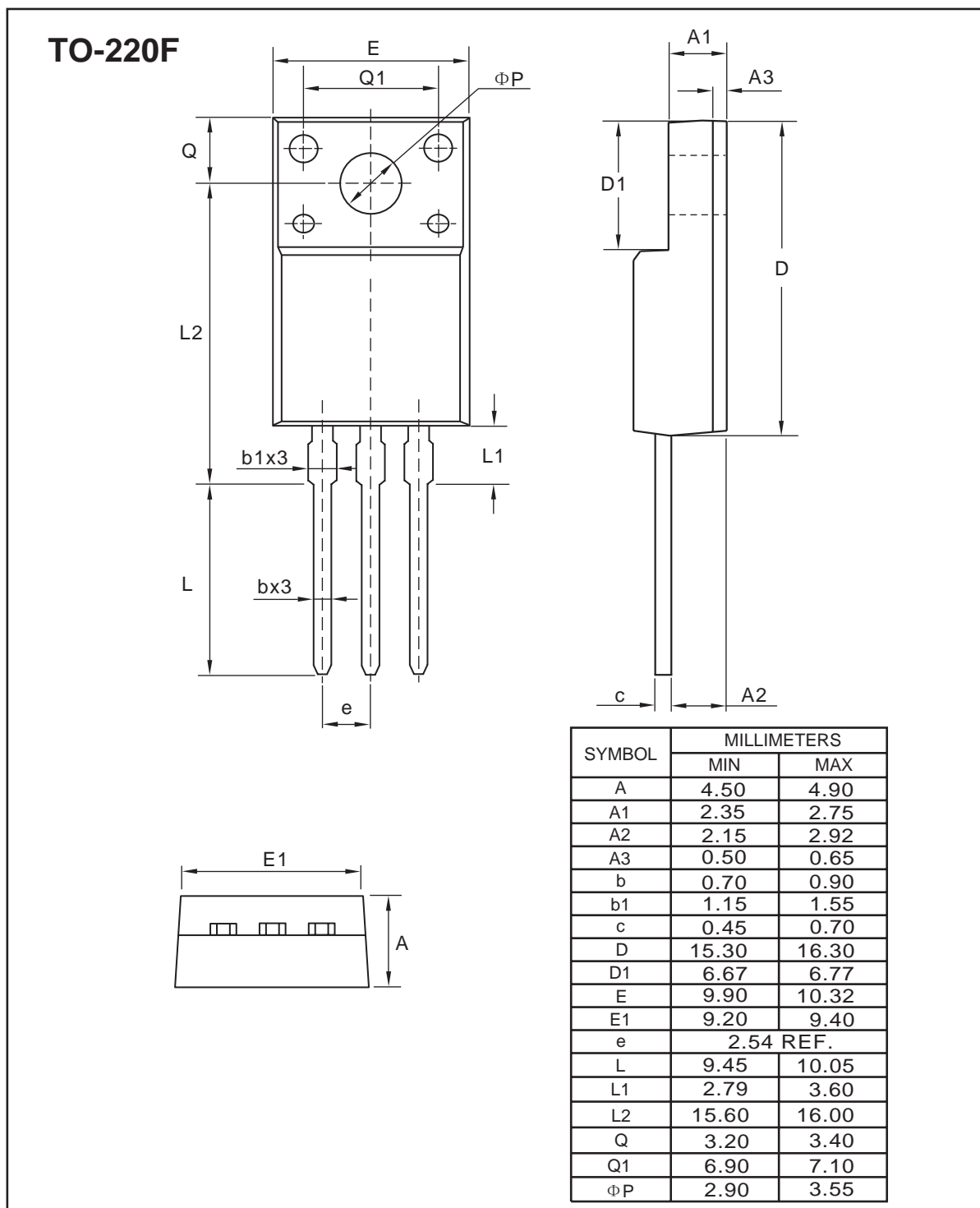
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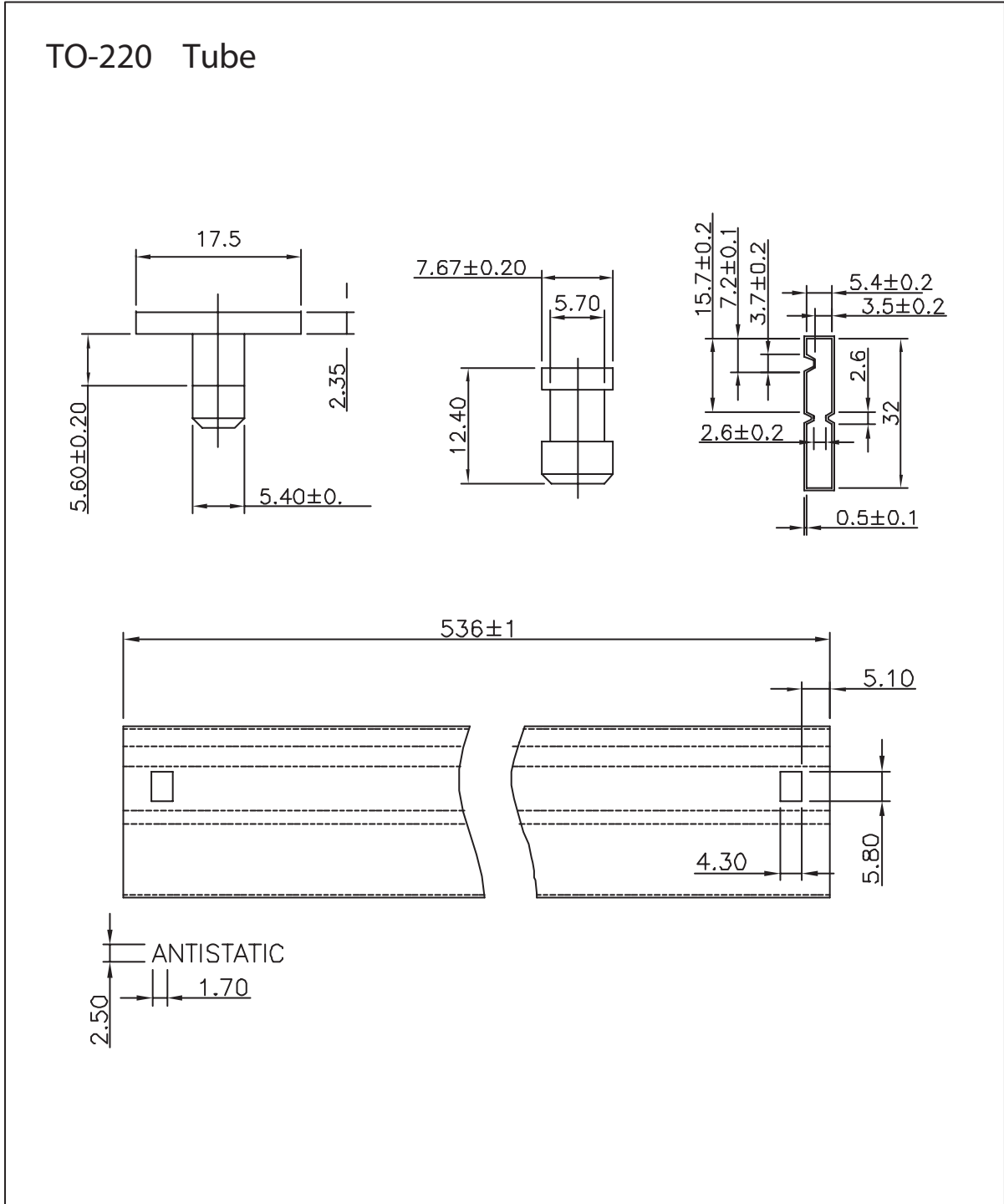
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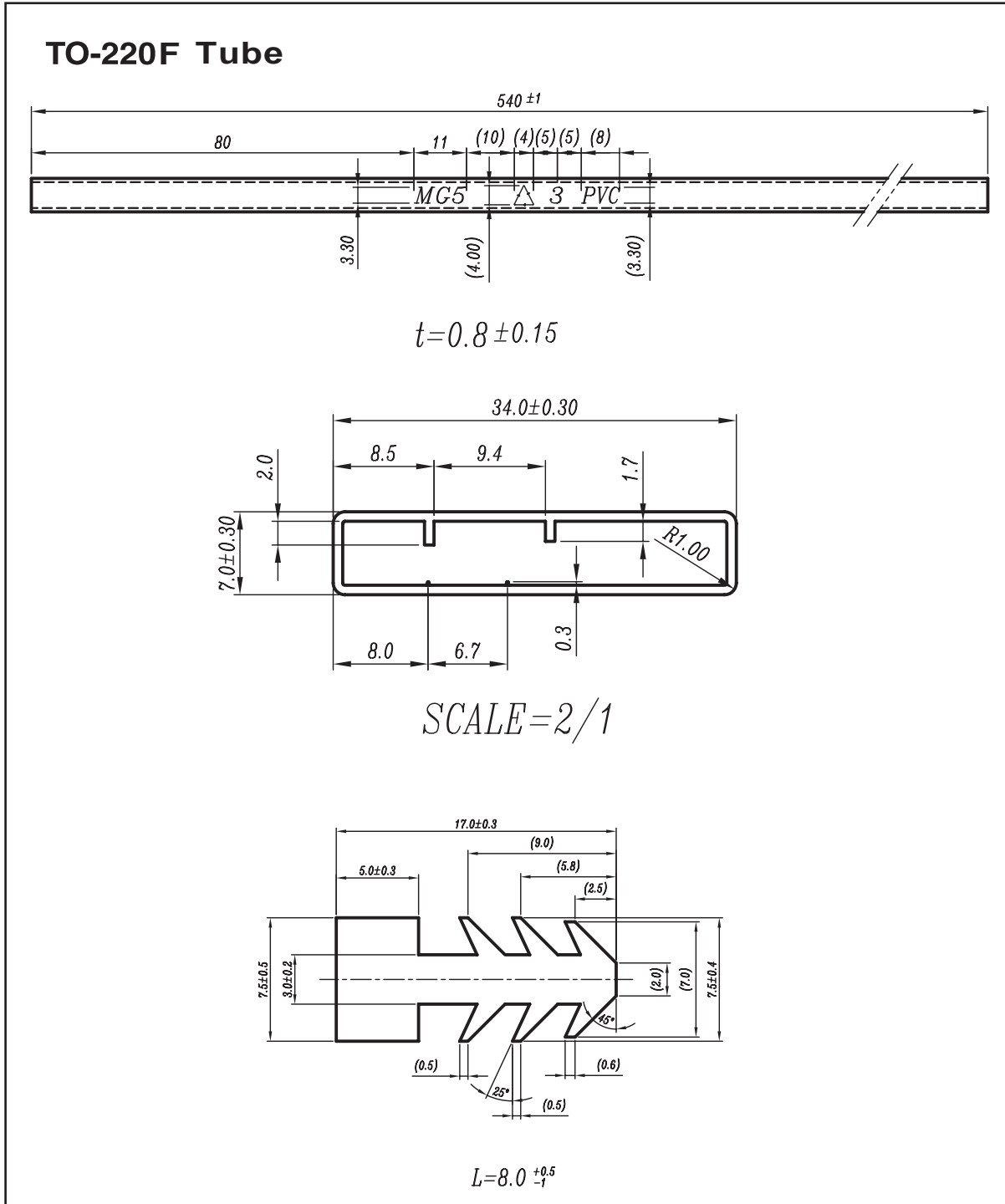
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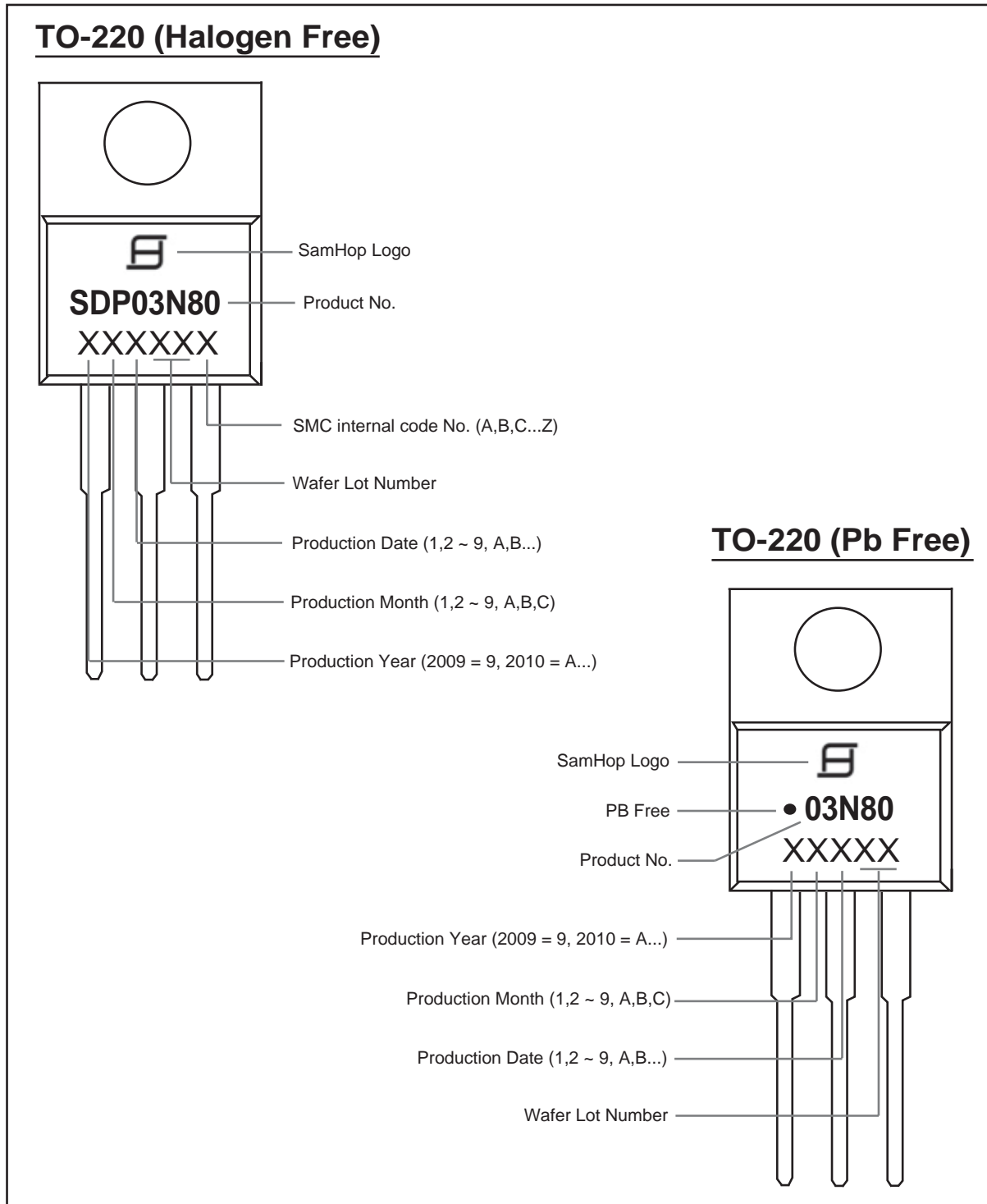
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TOP MARKING DEFINITION



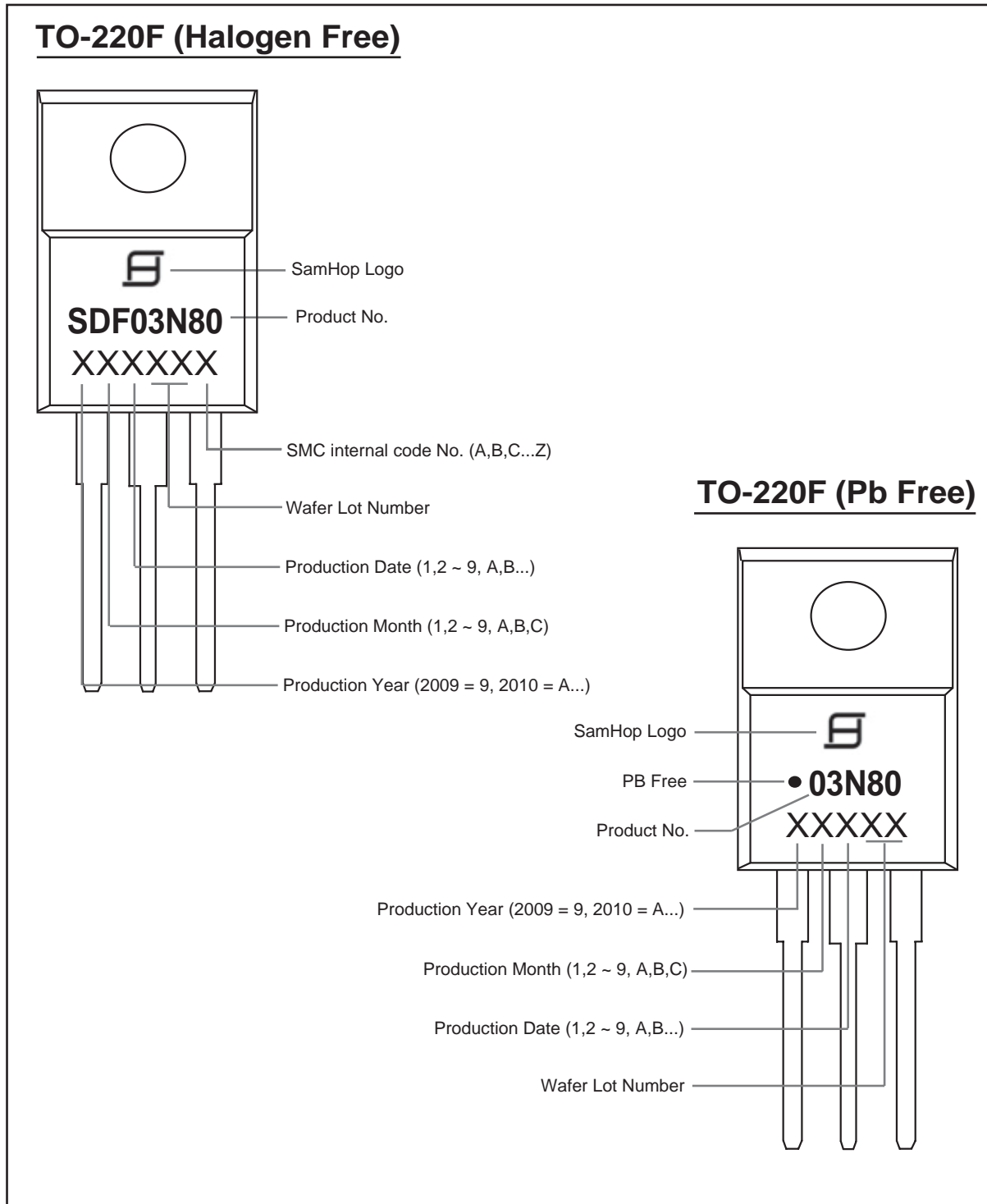
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